#### 查询8186供应商

8186

## 捷多邦,专业PCB打样工厂,24小时加急出货

## LOW-DROPOUT, 3.3 V REGULATOR — HIGH EFFICIENCY

Designed specifically to meet the requirement for extended operation of battery-powered equipment such as cordless and cellular telephones, the A8186SLU voltage regulator offers the reduced dropout voltage and quiescent current essential for maximum battery life. Applicable also to palmtop computers and personal data assistants, the device delivers a regulated, continuous 3.3 V output at up to 75 mA under normal operating conditions, or to 150 mA (transient) under worst-case conditions.

A PMOS pass element provides a typical dropout voltage of only 85 mV at 60 mA of load current. The low dropout voltage permits deeper battery discharge before output regulation is lost. Furthermore, quiescent current does not increase as the dropout voltage is approached, an ideal feature in standby/resume power systems where data integrity is crucial. Regulator accuracy and excellent temperature characteristics are provided by a bandgap reference. An ENABLE input gives the designer complete control over power up, standby, or power down.

This device is supplied in a 6-lead small-outline plastic package (similar to the SOT-89/TO-243AA) for surface-mount applications. The A8186SLU is rated for operation over a temperature range of -20°C to +85°C.

## FEATURES AND BENEFITS

- High Efficiency Provides Extended Battery Life
- **85** mV Typical Dropout Voltage at  $I_0 = 60$  mA
- 45 μA Typical Quiescent Current at V<sub>1</sub> = 6 V Less Than 1 µA "Sleep" Current
- CMOS-Compatible ON/OFF Control
  For Power-Up, Standter
- Internal Thermal Protection
- Surface-Mount Package

#### APPLICATIONS

- Cordless and Cellular Telephones
- Personal Data Assistants
- Personal Communicators
- Palmtop Computers

Always order by complete part number:

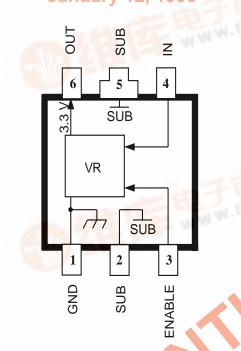
A8186SLU

df.dzsc.com



## **PRELIMINARY INFORMATION** (subject to change without notice)

January 12, 1995



ABSOLUTE MAXIMUM RATINGS

Input Voltage, V. ..... 10 V

Output Current, I<sub>0</sub> . . . . . . . . . **150 mA**\* Enable Input Voltage, V<sub>F</sub>.... V<sub>I</sub>

T<sub>A</sub> ..... -20°C to +85°C Junction Temperature, T<sub>1</sub> . . . +150°C<sup>†</sup>

Output current rating is limited by input voltage,

Fault conditions that produce excessive junction

duty cycle, and ambient temperature. Under any set of conditions, do not exceed a junction

temperature of +150°C. See next page.

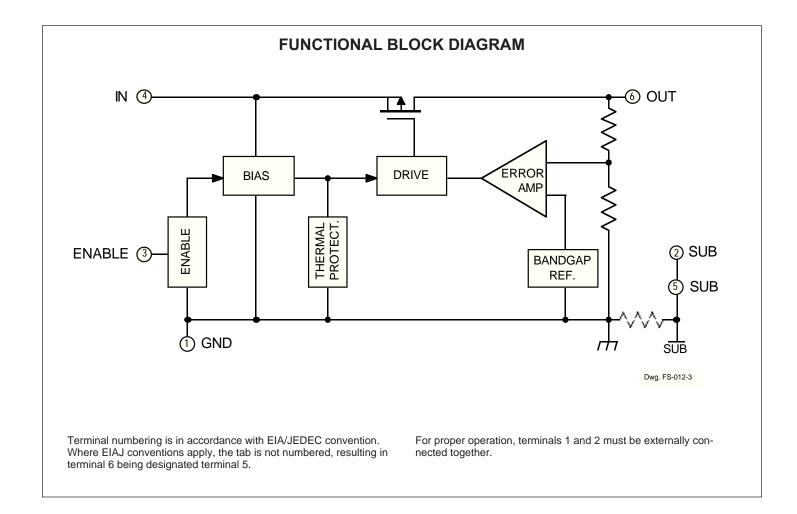
temperature will activate device thermal shutdown circuitry. These conditions can be

olerated but should be avoided.

Operating Temperature Range,

Storage Temperature Range,

Dwg. PS-021-



## MAXIMUM ALLOWABLE OUTPUT CURRENT with device mounted on 2.24" x 2.24" (56.9 mm x 56.9 mm) solder-coated copper-clad board in still air.

	Maximum Allowable Output Current in Milliamperes with V <sub>1</sub> = 8 V, T <sub>1</sub> = 150°C, Period $\leq$ 10 s*											
	dc (Duty Cycle)											
T <sub>A</sub>	100%	90%	80%	70%	60%	50%	40%	30%	20%			
25°C	100	115	125	145	150	150	150	150	150			
50°C	80	90	100	115	135	150	150	150	150			
70°C	65	70	80	90	110	130	150	150	150			
85°C	50	60	65	75	85	105	130	150	150			

\*  $I_{O} = (T_{J} - T_{A})/([V_{I} - V_{O}] R_{\theta JA} \bullet dc) = (150 - T_{A})/(4.7 \bullet 258 \bullet dc)$ 

Output current rating can be increased (to 150 mA maximum) by heat sinking or reducing the input voltage. Conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.



## ELECTRICAL CHARACTERISTICS at $T_A = +25^{\circ}C$ (unless otherwise noted).

			Limits				
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units	
Output Voltage	Vo	$4 \text{ V} \leq \text{V}_{I} \leq 8 \text{ V},$	T <sub>A</sub> = +25°C	3.25	3.30	3.35	V
		$10 \ \mu A \leq I_O \leq 100 \ mA^*$	$-20^{\circ}C \le T_A \le +85^{\circ}C$	3.20	3.30	3.40	V
	$V_1 = 3.3 \text{ V}, \text{ I}_0 = 60 \text{ mA}^*, -20^{\circ}\text{C} \le \text{T}_A \le +85^{\circ}$				—	—	V
Output Volt. Temp. Coeff.	α <sub>νο</sub>	V <sub>I</sub> = 6 V, I <sub>O</sub> = 10 mA	—	—	±1.0	mV/°C	
Line Regulation	$\Delta V_{O(\Delta VI)}$	$6 \text{ V} \le \text{V}_{I} \le 8 \text{ V}, \text{ I}_{O} = 1 \text{ mA}$		—	8.0	12	mV
		$4 \text{ V} \le \text{V}_{I} \le 6 \text{ V}, \text{ I}_{O} = 1 \text{ m}$	nA	—	10	20	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	$1 \text{ mA} \le I_0 \le 100 \text{ mA}^*, V_1 = 8 \text{ V}$		—	20	30	mV
		$1 \text{ mA} \leq I_{O} \leq 100 \text{ mA}^{*},$	V <sub>1</sub> = 6 V	—	13	25	mV
		$1 \text{ mA} \le I_0 \le 100 \text{ mA}^*,$	V <sub>1</sub> = 4 V	—	8.0	20	mV
Dropout Voltage	V <sub>I</sub> min - V <sub>O</sub>	l <sub>o</sub> = 60 mA*		—	85	150	mV
		l <sub>o</sub> = 125 mA*		_	190	300	mV
Quiescent Current	۱ <sub>Q</sub>	$V_{I} = 6 \text{ V}, 1 \text{ mA} \le I_{O} \le 100 \text{ mA}^{*}, V_{E} \ge 2.0 \text{ V}$		—	45	60	μA
(GND terminal current)		$V_{I} = 8 V, 1 mA \le I_{O} \le 1$	00 mA*, $V_{E} \ge 2.0 V$	—	50	65	μΑ
	I <sub>Q(off)</sub>	$4 \text{ V} \le \text{V}_{\text{I}} \le 8 \text{ V}, \text{ V}_{\text{E}} \le 0.8 \text{ V}$		—	0.05	1.0	μA
ENABLE Input Voltage	V <sub>EH</sub>	$4 \text{ V} \leq \text{V}_{I} \leq 8 \text{ V},$	Output ON	2.0	_	_	V
	V <sub>EL</sub>	$-20^{\circ}C \le T_A \le +85^{\circ}C$	Output OFF	—	_	0.8	V
ENABLE Input Current	Ι <sub>Ε</sub>	$I_{\rm E}$ $T_{\rm A} \le +85^{\circ}{\rm C}, \ V_{\rm E} = V_{\rm I} = 8 \ {\rm V}$			_	±0.1	μA
Thermal Shutdown Temp.	TJ			150	_	_	°C
Thermal Resistance	R <sub>θJA</sub>	Mounted on 2.24" x 2.24" solder-coated copper-clad board in still air			258		°C/W

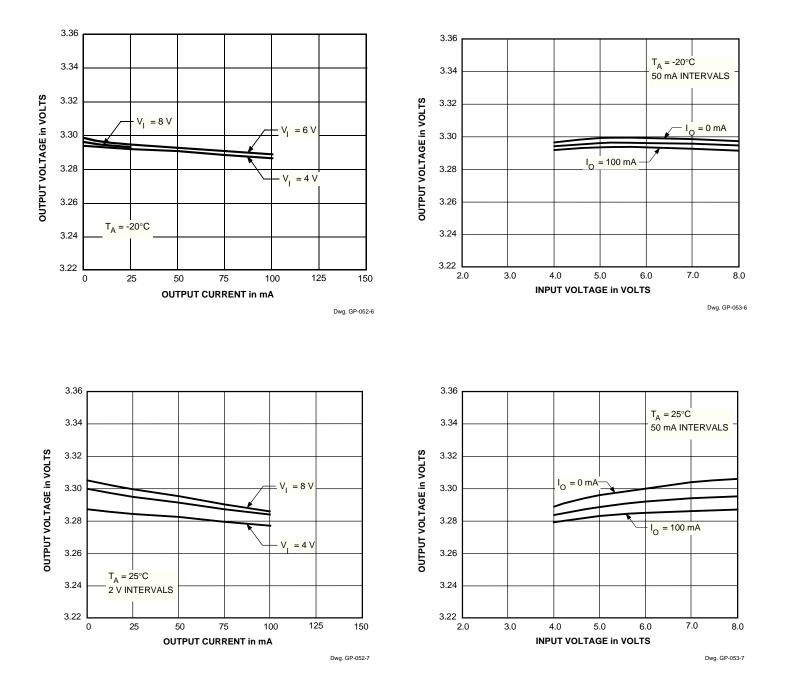
Typical values are at  $T_A = +25^{\circ}C$  and are given for circuit design information only.

\* Pulse test (<20 ms). See previous page for duty cycle limitations.

#### **TYPICAL CHARACTERISTICS**

#### LOAD REGULATION

#### LINE REGULATION



CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.

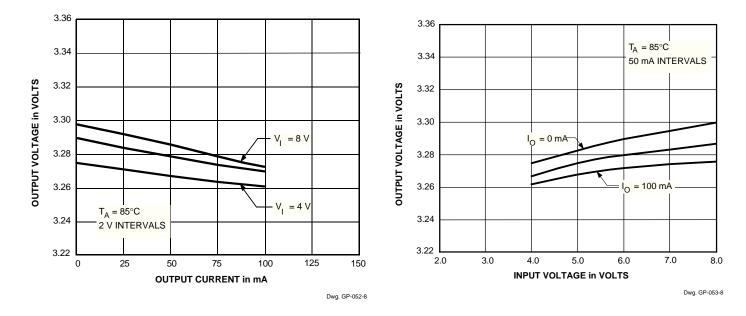


115 Northoast Cutoff Box 15026

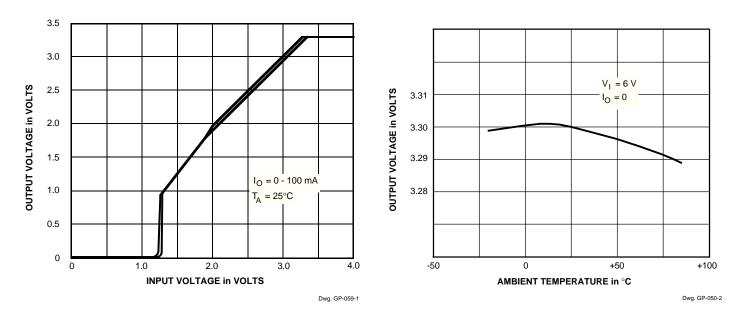
#### **TYPICAL CHARACTERISTICS (cont,d)**

#### LOAD REGULATION

#### LINE REGULATION



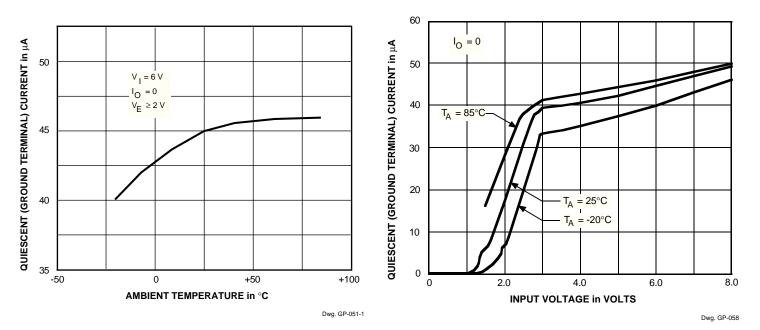
**OUTPUT VOLTAGE** 



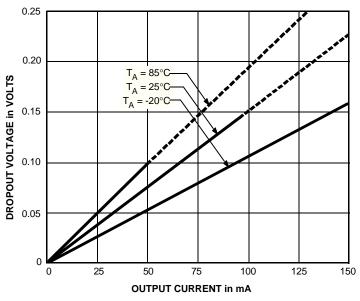
CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.

#### **TYPICAL CHARACTERISTICS (cont,d)**

#### QUIESCENT (GROUND TERMINAL) CURRENT



**DROPOUT VOLTAGE** 



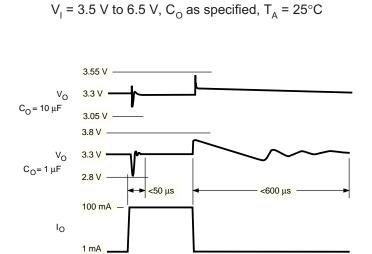
Dwg. GP-054-1

CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.



115 Northoast Cutoff, Box 15036

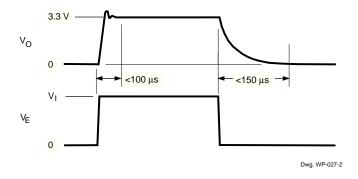
#### **TYPICAL CHARACTERISTICS (concluded)**



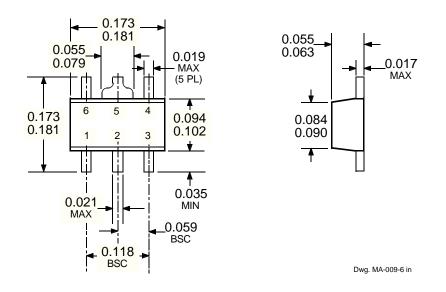
LOAD TRANSIENT PERFORMANCE



V<sub>I</sub> = 3.5 V to 6.5 V, C<sub>O</sub> = 1  $\mu$ F, T<sub>A</sub> = 25°C

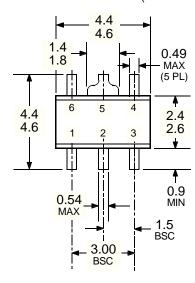


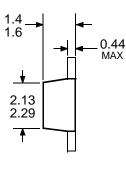
Dwg. WP-028-1



Dimensions in Inches (for reference only)

## **Dimensions in Millimeters** (controlling dimensions)





Dwg. MA-009-6 mm

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the design of its products. The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.

#### NOTES: 1. Lead spacing tolerance is non-cumulative.

- 2. Exact body and lead configuration at vendor's option within limits shown.
- 3. Terminal numbering is in accordance with EIA/JEDEC convention. Where EIAJ conventions apply, the tab is not numbered, resulting in terminal 6 being designated terminal 5.

